

# EAST Search History

JRF 3/6/06

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L29	66769	micron and semiconductor	USPAT	OR	ON	2006/03/06 14:45
L30	10200	micron and semiconductor and lead and adhesive	US-PGPUB; USPAT	OR	ON	2006/03/06 14:45
L31	10880	semiconductor adj die	US-PGPUB; USPAT	OR	ON	2006/03/06 14:45
L32	19650	lead adj frame	US-PGPUB; USPAT	OR	ON	2006/03/06 14:46
L33	1175	31 and 32 and micron	US-PGPUB; USPAT	OR	ON	2006/03/06 14:46
L34	843	33 and adhesive	US-PGPUB; USPAT	OR	ON	2006/03/06 14:46
L35	731	34 and (die same frame)	US-PGPUB; USPAT	OR	ON	2006/03/06 14:47
L36	2	"6610162"	US-PGPUB; USPAT	OR	ON	2006/03/06 14:48
L38	156	35 and kinsman	US-PGPUB; USPAT	OR	ON	2006/03/06 14:48
L39	2	36	US-PGPUB; USPAT	OR	ON	2006/03/06 14:48
L40	147	35 and kinsman	USPAT	OR	ON	2006/03/06 15:12
L41	8	"6277225"	USPAT	OR	ON	2006/03/06 15:16
L42	30	(semiconductor and lead and adhesive and stress).clm.	US-PGPUB	OR	ON	2006/03/06 15:16